

N-Channel Lateral DMOS FETs

Product Summary

Part Number	$V_{(BR)DS}$ Min (V)	$V_{GS(th)}$ Max (V)	$r_{DS(on)}$ Max (Ω)	C_{rss} Max (pF)	t_{ON} Max (ns)
SD210DE	30	1.5	45 @ $V_{GS} = 10$ V	0.5	2
SD214DE	20	1.5	45 @ $V_{GS} = 10$ V	0.5	2

SD214DE, For applications information see AN301, page 33.

Features

- Ultra-High Speed Switching— t_{ON} : 1 ns
- Ultra-Low Reverse Capacitance: 0.2 pF
- Low Guaranteed r_{DS} @ 5 V
- Low Turn-On Threshold Voltage
- N-Channel Enhancement Mode

Benefits

- High Speed System Performance
- Low Insertion Loss at High Frequencies
- Low Transfer Signal Loss
- Simple Driver Requirement
- Single Supply Operation

Applications

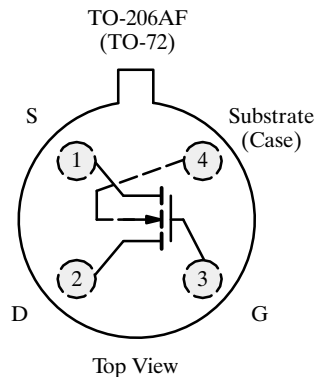
- Fast Analog Switch
- Fast Sample-and-Holds
- Pixel-Rate Switching
- DAC Deglitchers
- High-Speed Driver

Description

The SD210DE/214DE are enhancement-mode MOSFETs designed for high speed low-glitch switching in audio, video, and high-frequency applications. The SD214DE is normally used for ± 10 -V analog switching. These MOSFETs utilize lateral construction to achieve low capacitance and ultra-fast switching speeds. These MOSFETs do not have a gate protection Zener diode

which results in lower gate leakage and \pm voltage capability from gate to substrate. A poly-silicon gate is featured for manufacturing reliability.

For similar products see: quad array—SD5000/5400 series, and Zener protected—SD211DE/SST211 series.



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Gate-Drain, Gate-Source Voltage	± 40 V	Drain Current	50 mA
Gate-Substrate Voltage	± 40 V	Lead Temperature ($^{1/16}$ " from case for 10 seconds)	300°C
Drain-Source Voltage (SD210DE)	30 V	Storage Temperature	-65 to 150°C
Drain-Source Voltage (SD214DE)	20 V	Operating Junction Temperature	-55 to 125°C
Source-Drain Voltage (SD210DE)	10 V	Power Dissipation ^a	300 mW
Source-Drain Voltage (SD214DE)	20 V		
Drain-Substrate Voltage (SD210DE)	30 V	Notes:	
Drain-Substrate Voltage (SD214DE)	25 V	a. Derate 3 mW/ $^\circ\text{C}$ above 25°C	
Source-Substrate Voltage (SD210DE)	15 V		
Source-Substrate Voltage (SD214DE)	25 V		

Specifications^a

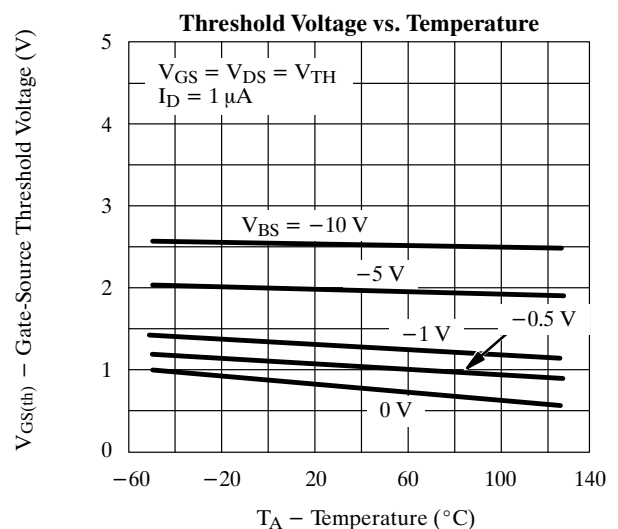
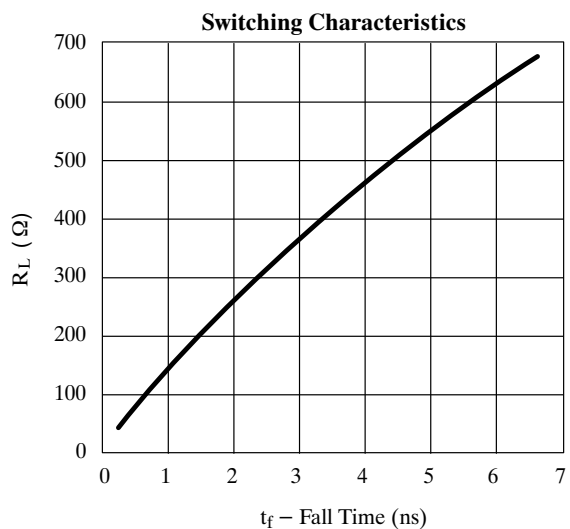
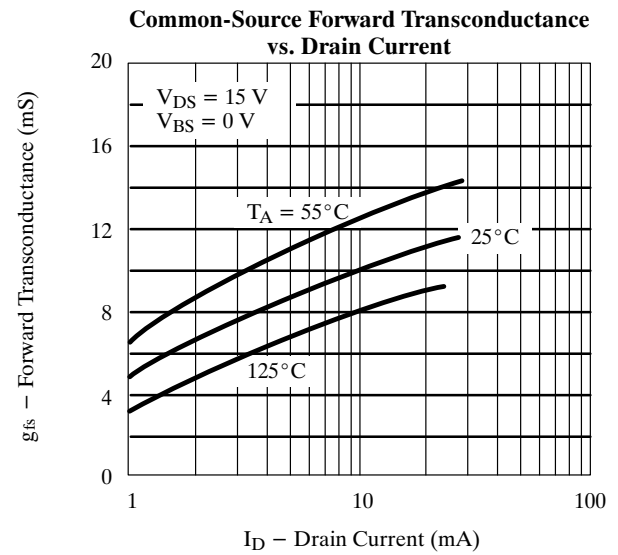
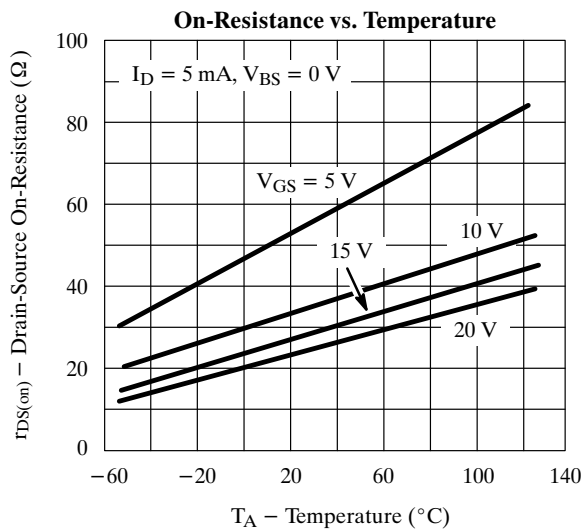
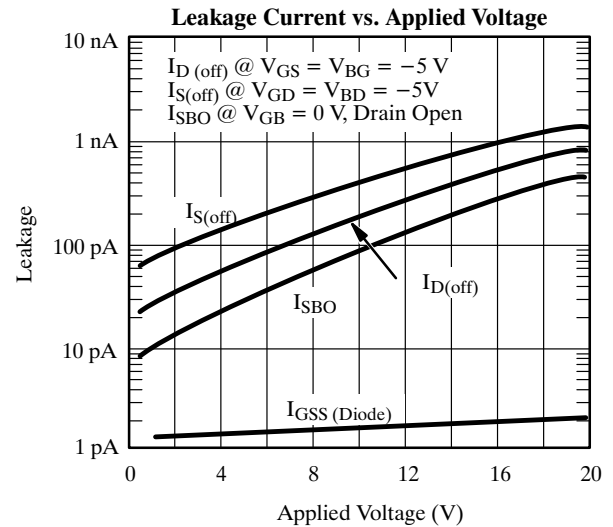
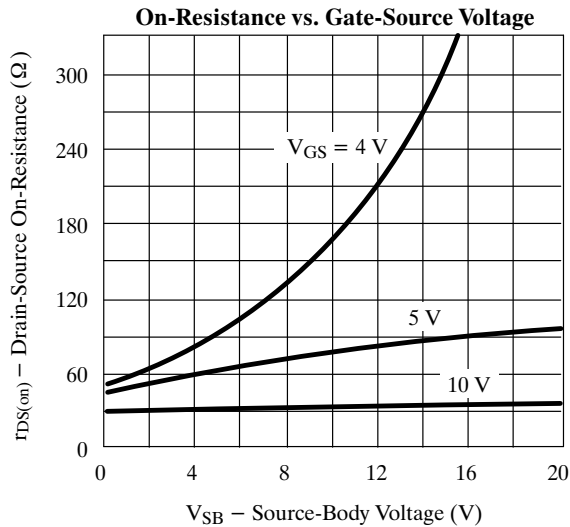
Parameter	Symbol ^b	Test Conditions ^b	Typ ^c	Limits				Unit
				SD210DE		SD214DE		
				Min	Max	Min	Max	
Static								
Drain-Source Breakdown Voltage	$V_{(BR)DS}$	$V_{GS} = V_{BS} = 0\text{ V}, I_D = 10\ \mu\text{A}$	35	30				V
		$V_{GS} = V_{BS} = -5\text{ V}, I_D = 10\ \text{nA}$	30	10		20		
Source-Drain Breakdown Voltage	$V_{(BR)SD}$	$V_{GD} = V_{BD} = -5\text{ V}, I_S = 10\ \text{nA}$	22	10		20		
Drain-Substrate Breakdown Voltage	$V_{(BR)DBO}$	$V_{GB} = 0\text{ V}, I_D = 10\ \mu\text{A},$ Source Open	35	15		25		
Source-Substrate Breakdown Voltage	$V_{(BR)SBO}$	$V_{GB} = 0\text{ V}, I_S = 10\ \mu\text{A},$ Drain Open	35	15		25		
Drain-Source Leakage	$I_{DS(off)}$	$V_{GS} = V_{BS} = -5\text{ V}$	$V_{DS} = 10\text{ V}$	0.4		10		nA
			$V_{DS} = 20\text{ V}$	0.9			10	
Source-Drain Leakage	$I_{SD(off)}$	$V_{GD} = V_{BD} = -5\text{ V}$	$V_{SD} = 10\text{ V}$	0.5		10		
			$V_{SD} = 20\text{ V}$	0.8			10	
Gate Leakage	I_{GBS}	$V_{DB} = V_{SB} = 0\text{ V}, V_{GB} = \pm 40\text{ V}$	0.001		0.1		0.1	
Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1\ \mu\text{A}, V_{SB} = 0\text{ V}$	0.8	0.5	1.5	0.1	1.5	V
Drain-Source On-Resistance	$r_{DS(on)}$	$V_{SB} = 0\text{ V}$ $I_D = 1\ \text{mA}$	$V_{GS} = 5\text{ V}$	58		70		Ω
			$V_{GS} = 10\text{ V}$	38		45		
			$V_{GS} = 15\text{ V}$	30				
			$V_{GS} = 20\text{ V}$	26				
			$V_{GS} = 25\text{ V}$	24				
Dynamic								
Forward Transconductance	g_{fs}	$V_{DS} = 10\text{ V}, V_{SB} = 0\text{ V}, I_D = 20\ \text{mA}$ $f = 1\ \text{kHz}$	11	10		10		mS
	g_{os}		0.9					
Gate Node Capacitance	$C_{(GS+GD+GB)}$	$V_{DS} = 10\text{ V}, f = 1\ \text{MHz}$ $V_{GS} = V_{BS} = -15\text{ V}$	2.5		3.5		3.5	pF
Drain Node Capacitance	$C_{(GD+DB)}$		1.1		1.5		1.5	
Source Node Capacitance	$C_{(GS+SB)}$		3.7		5.5		5.5	
Reverse Transfer Capacitance	C_{rss}		0.2		0.5		0.5	
Switching								
Turn-On Time	$t_{d(on)}$	$V_{SB} = 0\text{ V}, V_{IN} 0\text{ to }5\text{ V}, R_G = 25\ \Omega$ $V_{DD} = 5\text{ V}, R_L = 680\ \Omega$	0.5		1		1	ns
	t_r		0.6		1		1	
Turn-Off Time	$t_{d(off)}$		2					
	t_f		6					

Notes:

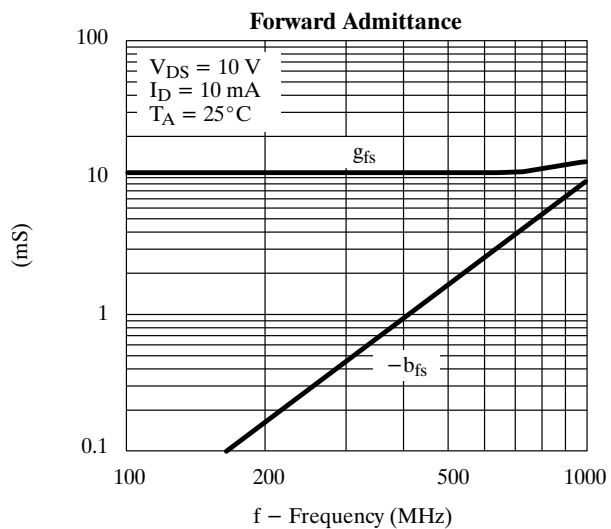
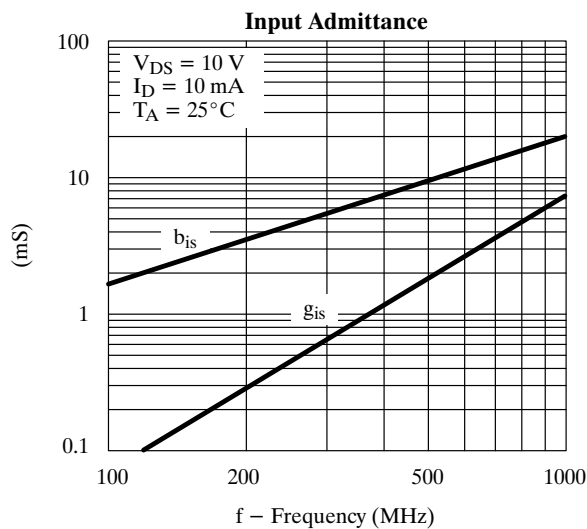
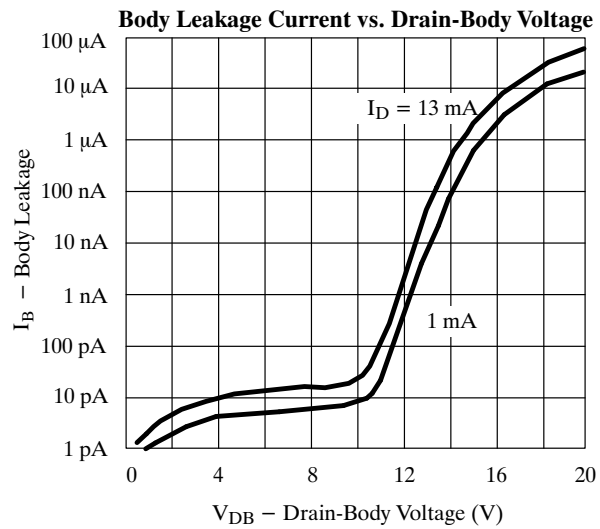
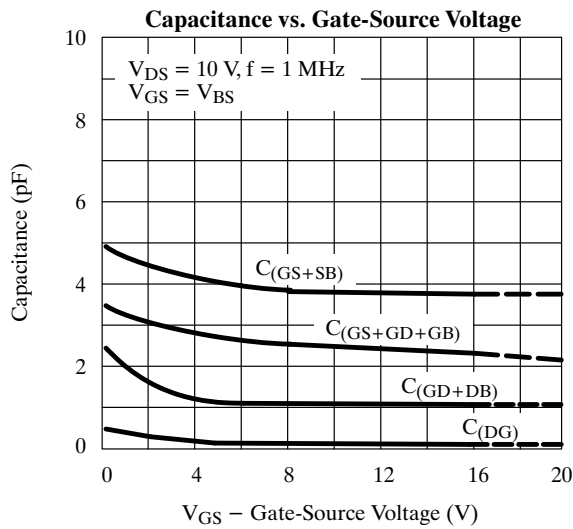
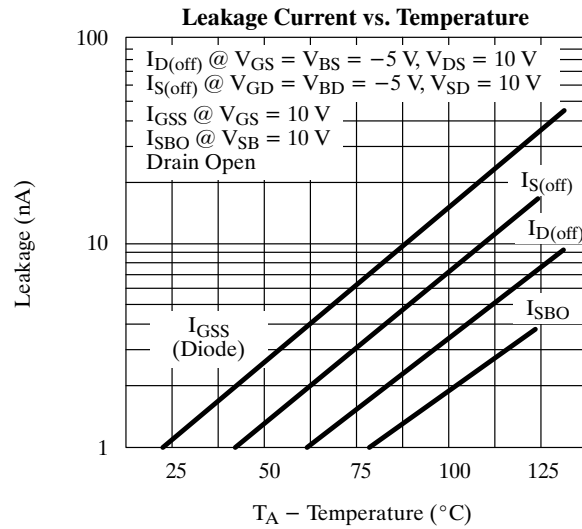
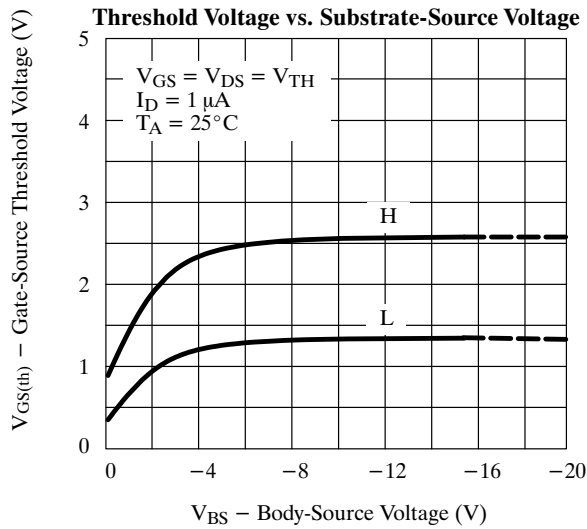
- $T_A = 25^\circ\text{C}$ unless otherwise noted.
- B is is the body (substrate) and $V_{(BR)}$ is breakdown.
- Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

DMCBB

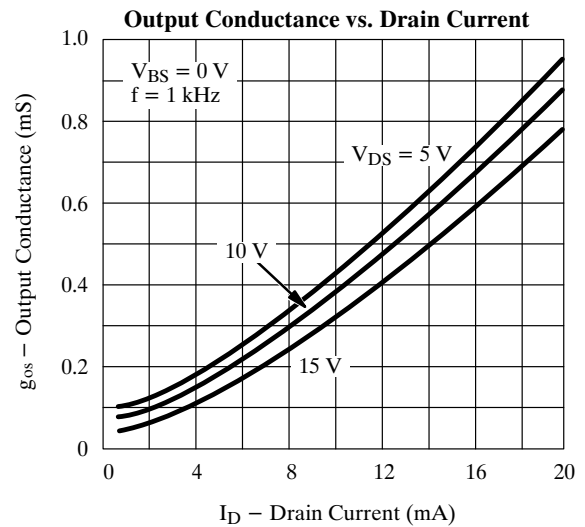
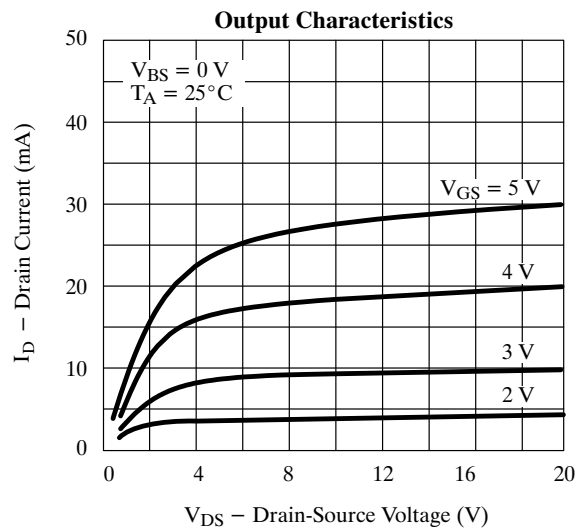
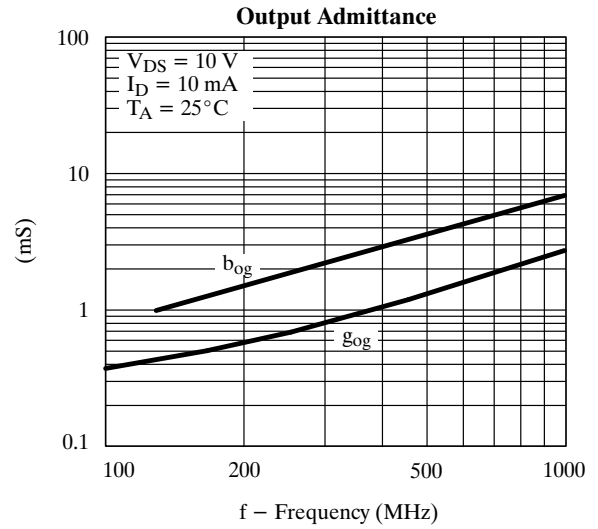
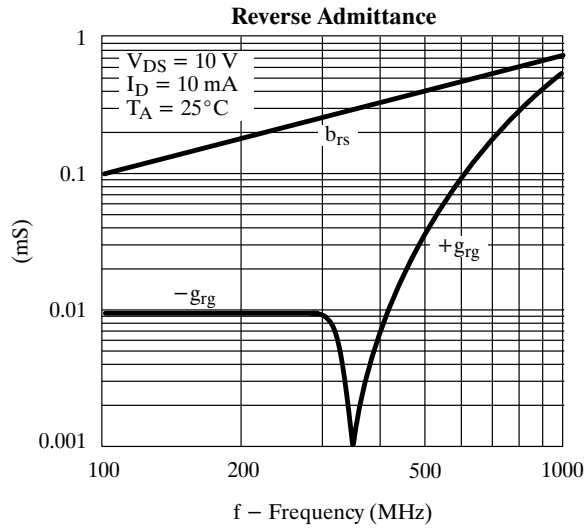
Typical Characteristics



Typical Characteristics (Cont'd)



Typical Characteristics



Switching Time Test Circuit

